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03W #1

oplicants:

Yoshimura, et al.

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CERTIFICATE OF MAILING/TRANSMISSION (37 C.F.R. § 1.8(a))

I hereby certify that this correspondence is, on the date shown below is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to Commissioner for Patents, U.S. Patent and Trademark Office, Washington, D.C. 20231

March 25, 2002

Mary M. Padilla

PRELIMINARY AMENDMENT

Commissioner for Patents U.S. Patent and Trademark Office Washington, D.C. 20231

Dear Sir:

IN THE DRAWINGS

Please correct Figs. 420 and 421 in accordance with the red ink corrections labeled on the accompanying drawings.

Approval from the Examiner is respectfully requested.

IN THE SPECIFICATION

Please amend page 17, lines 19 through 22 as follows:

FIGS. 414-419 are perspective views for representing the process for fabricating a substrate having three different types of dimensional walls; and

FIG. 420 is a vertical sectional view through a substrate containing sections which were formed by the process steps illustrated in FIGS. 414-419.

REMARKS

Applicant preliminarily amends the above-identified application in accordance with the forgoing amendment. Inadvertently "Fig. 419" was omitted from the drawings. "Fig. 419" was described on page 17 of the specification.

Therefore, applicants have amended respectively Figs. 420 and 421 to be "Fig. 419" and "Fig. 420". Thus the forgoing amendment should obviate the December 21, 2001 "Notice of Omitted Item(s) in a Nonprovisional Application", a copy which is attached hereto.

Respectfully submitted,

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MARKED-UP VERSION

The Specification has been amended as follows:

FIGS. 414-420 419 are perspective views for representing the process for fabricating a substrate having three different types of dimensional walls; and FIG. 421 420 is a vertical sectional view through a substrate containing sections

which were formed by the process steps illustrated in FIGS. 414-420 419.